

# **EASYPDKPROG Lite**

A simplified version of the EASYPDKPROG that is manufacturable at JLCPCB

# Design goals

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1. Retain functionality of the original
2. Reduce types of different components in BOM, wherever possible
3. Try to use only parts from the „Basic“ parts catalogue of JLCPCB
4. Reduce component count wherever possible
5. Allow depop of some parts, e.g. Pushbutton, XTAL
6. Relax spacing between component to ease assembly, especially for USB connector
7. Add silk screen

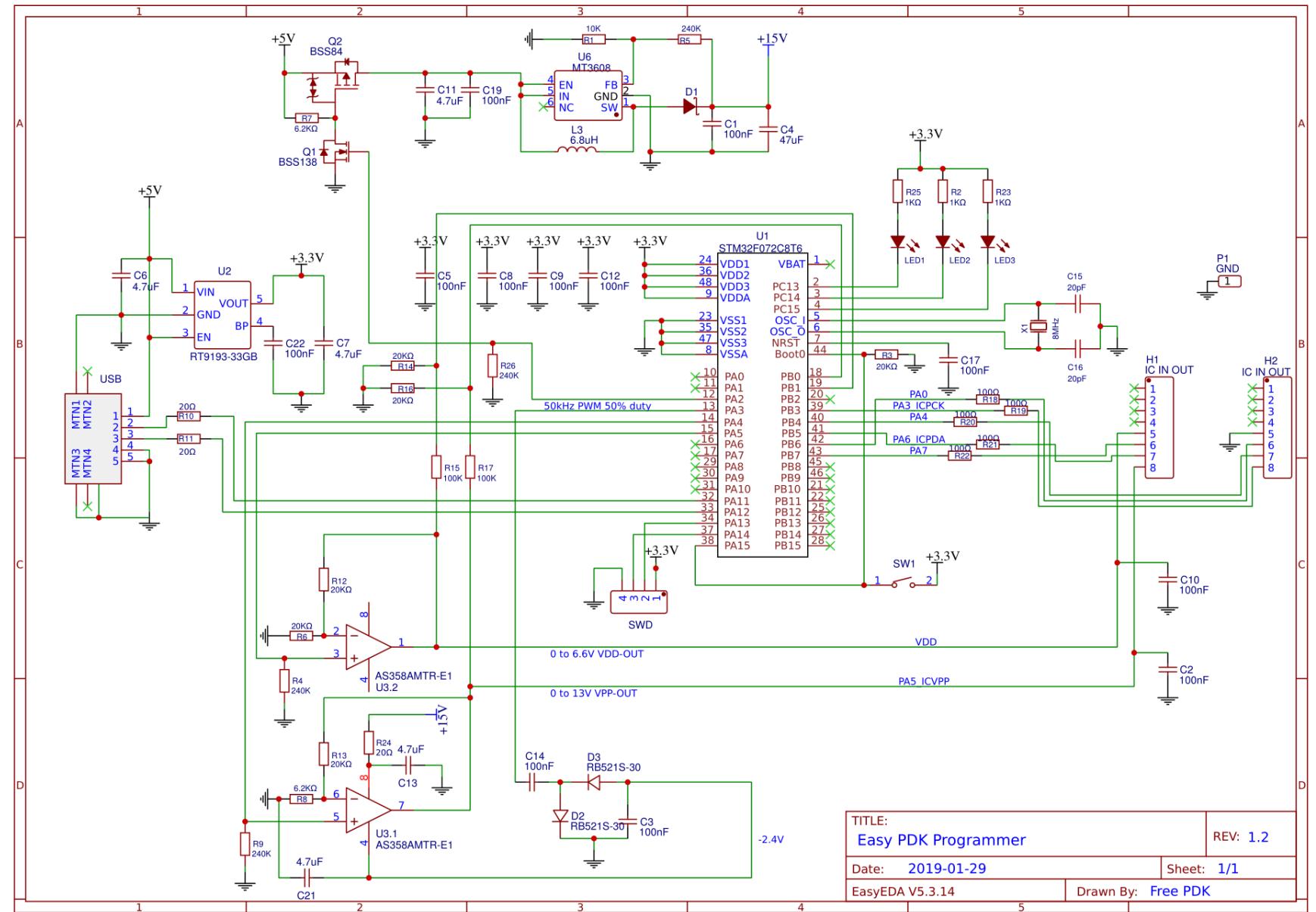
# Schematic of original



[easypdkprog\\_schematic12.pdf](#)



[easypdkprog\\_easyedafile12.zip](#)



# Ideas

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- Remove negative power supply to OPAMPS -> output can go 20mV to ground, this should be sufficient
- Remove input switch from DC-DC converter -> Opamps can do power gating
- Remove additional RC filter for OPAMP supply -> loop gain should be high enough to tolerate some power noise. PSRR of opamp is xx dB anyways.
- Replace step-up converter with one from basic components at JLCPCB
- Replace inductor with SMD type (or two?) from basic selection. -> there is no suitable power inductor.
- Extra clearance for USB connector to allow for easier soldering
- More regular layout for resistors with more spacing
- Remove XTAL? -> no, needs adaption of software

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XC6206P332MR

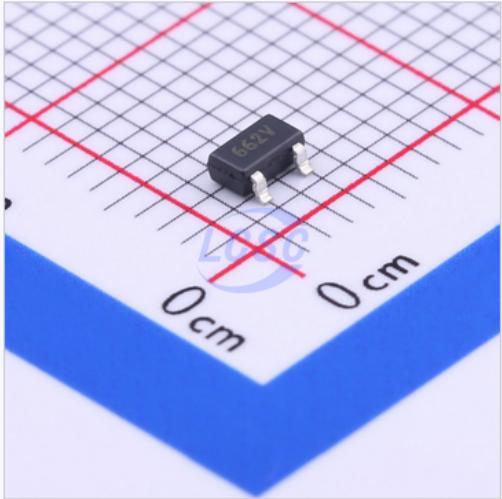


LOW DROPOUT REGULATORS(LDO) POSITIVE FIXED 680 Basic Part

TOREX SEMICON

50542

1+ \$0.0948



Torex Semicon XC6206P332MR

JLCPCB Warehouse

Sales Unit: Piece Full Reel: 50542

Manufacturer Torex Semicon

Qty.

Unit Price

MFR.Part # XC6206P332MR

1+

\$0.0948

LCSC Part # C5446

100+

\$0.0562

Package SOT-23-3L

Description LOW DROPOUT REGULATORS(LDO)  
POSITIVE FIXED 680MV @ 100MA 6V  
3.3V 200MA SOT-23-3L ROHS

Datasheet Torex-Semicon-  
XC6206P332MR\_C5446.pdf

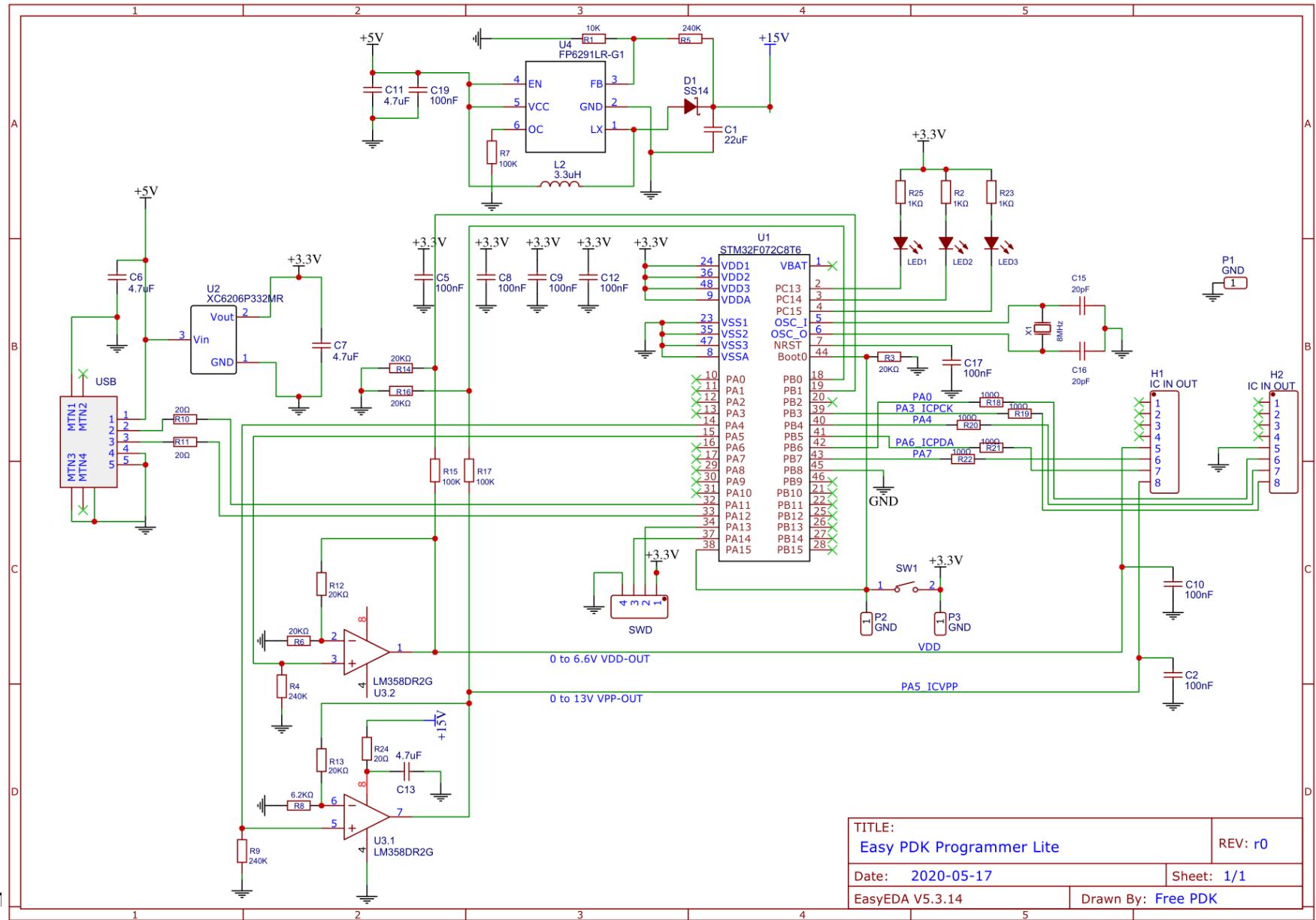
EasyEDA Libraries: EasyEDA

# Change log original -> r0

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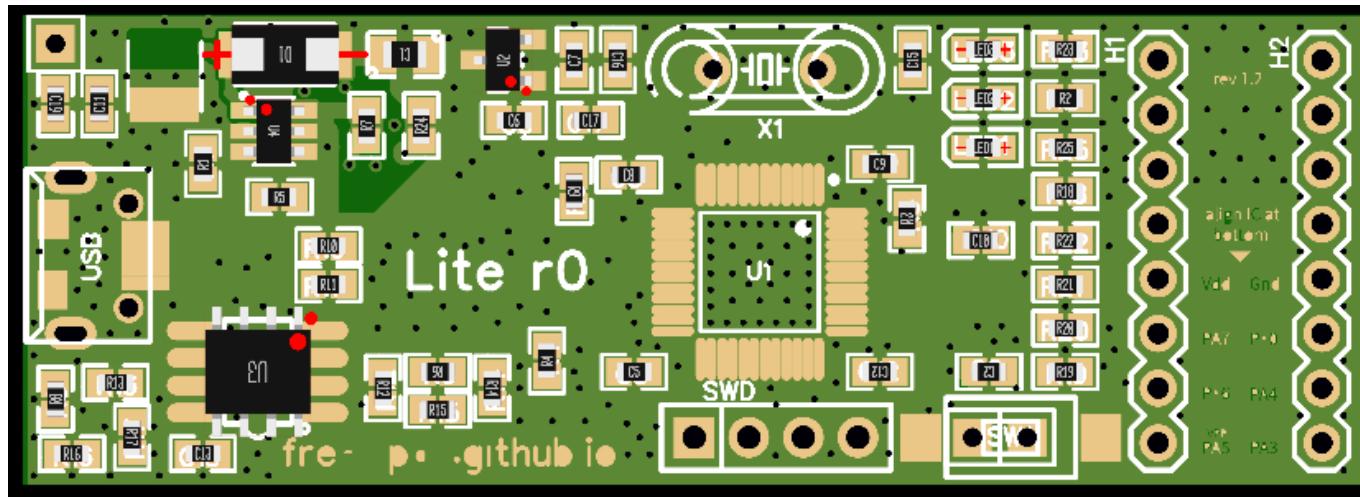
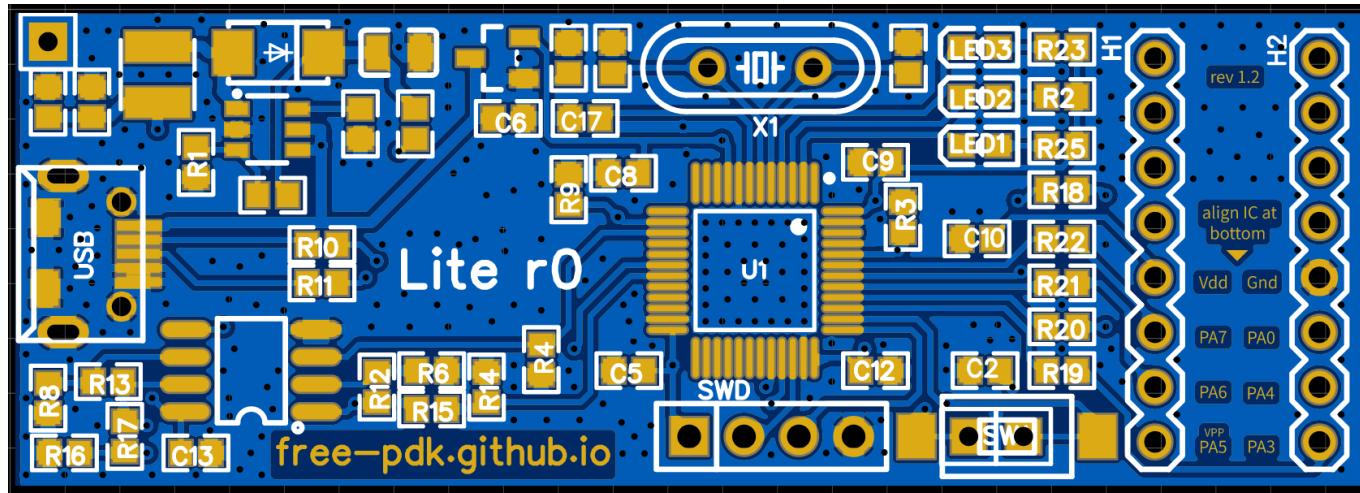
- Removed negative Bias generator and connected Opamp to ground (C3,C14,C21,D2,D3 removed)
- Removed enable circuit for 12 V boost generator (Q1,Q2,R7,R26)
- Increased width of 5V rail to 20mil
- Moved R10,R11 to allow easier soldering of the USB connector
- Moved C5, C9, C12 to allow easier soldering of MCU
- Added „Lite r0“ silk screen
- Moved C10 for better alignment with resistors
- Added optional pins for buttonless activation of the bootlader
- Replace D1 with SS14 in different package (basic part)
- Replace RT9193 with XC6206P33 (basic part), remove bandgap cap (not needed for XC6206)
- Replace C4 with 22 $\mu$ F cap instead of 47 $\mu$ F. No 47 $\mu$  cap as basic part available, 22 $\mu$  is still sufficient according to datasheet. C1 removed, since it is redundant with the additional RC filter.
- Replaced AS358 with LM358 (Basic part)
- Replace MT3680 with FP6291, add 100k current limiting resistor, to limit to 480mA current. Replaced L1 with 3.3 $\mu$ H. (3.3 $\mu$ m is recommended in datasheet, 6.8 $\mu$ H seems too high for FP6291)
- Connected PB8 (Pin 45) of the MCU to ground to be able to detect the lite version from software.

# Revision 0 Design, Schematics



# Revision 0 design, PCB

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easypdkprog\_lite\_may30.zip

# List of parts not populated

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Designator	Name	Footprint	Quantity	Note
SW1	1TS002E-2700-2500	KEY-TACT-SMD-6.1*3.7*2.5		1 Optional, can use wire bridge to invoke bootloader
X1	8MHZ	HC-49S		1 Optional, need to update firmware to use internal oscillator
H1	IC IN OUT	210S-1X8P		1 <b>Mandatory, programming header</b>
H2	IC IN OUT	210S-1X8P		1 <b>Mandatory, programming header</b>
L2	3.3UH	IND-SMD_L3.0-W3.0		1 <b>Mandatory</b>
USB	MICRO USBFEMALE	MICRO-USB-1		1 <b>Mandatory</b>
SWD	SWD	DIP-1X4P-2.54MM-M		1 Optional, only needed for development

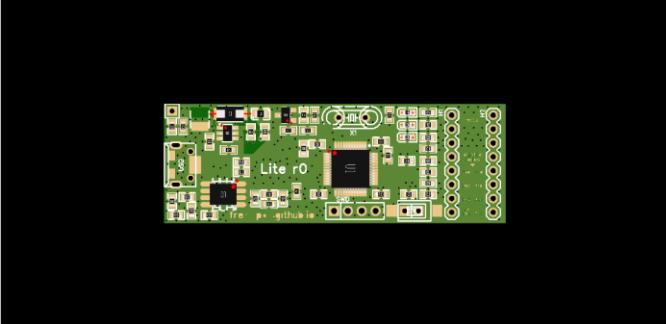
## Note

- X1,H1,H2 are through hole parts and cannot be populated by JLCPCB
- L2 is not available at JLCPCB and needs to be mounted manually
- USB cannot be populated by JLCPCB

# Cost at JLCPCB

50 pc

Review Parts Placement



The parts placement is for reference purpose only. If you are sure the rotation and polarity of your design are correct, you can omit the preview and continue placing your order.

Selected Parts(18 items) [?](#)

Part Detail	Selected By	Designator	Price
PCB Components   18 items			

Charge Details

Engineering fee: \$8.00  
Board: \$3.10

SMT Price:

Setup fee: \$7.00  
Stencil: \$1.50  
Panel: \$0.00  
Components: \$83.32  
Extended components fee: \$3.00  
Assembly: \$0.00

Build Time:

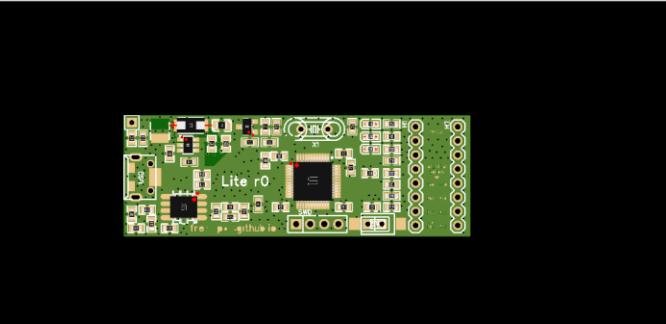
PCB:  5-6 days \$0.00  
SMT: 48 hours

Total Price: \$105.92  
Weight: 280.33g

[SAVE TO CART](#)

5 pc

Review Parts Placement



The parts placement is for reference purpose only. If you are sure the rotation and polarity of your design are correct, you can omit the preview and continue placing your order.

Selected Parts(18 items) [?](#)

Part Detail	Selected By	Designator	Price
PCB Components   18 items			

Charge Details

Special Offer: \$2.00

SMT Price:

Setup fee: \$7.00  
Stencil: \$1.50  
Panel: \$0.00  
Components: \$13.24  
Extended components fee: \$3.00  
Assembly: \$0.00

Build Time:

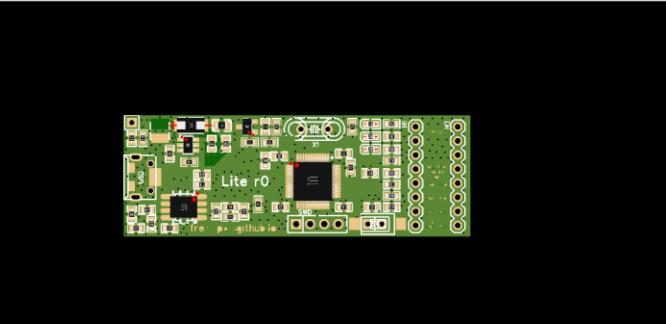
PCB:  1-2 days \$0.00  
SMT: 48 hours

Total Price: \$26.74  
Weight: 36.41g

[SAVE TO CART](#)

10 pc

Review Parts Placement



The parts placement is for reference purpose only. If you are sure the rotation and polarity of your design are correct, you can omit the preview and continue placing your order.

Selected Parts(18 items) [?](#)

Part Detail	Selected By	Designator	Price
PCB Components   18 items			

Charge Details

Special Offer: \$5.00

SMT Price:

Setup fee: \$7.00  
Stencil: \$1.50  
Panel: \$0.00  
Components: \$21.37  
Extended components fee: \$3.00  
Assembly: \$0.00

Build Time:

PCB:  1-2 days \$0.00  
SMT: 48 hours

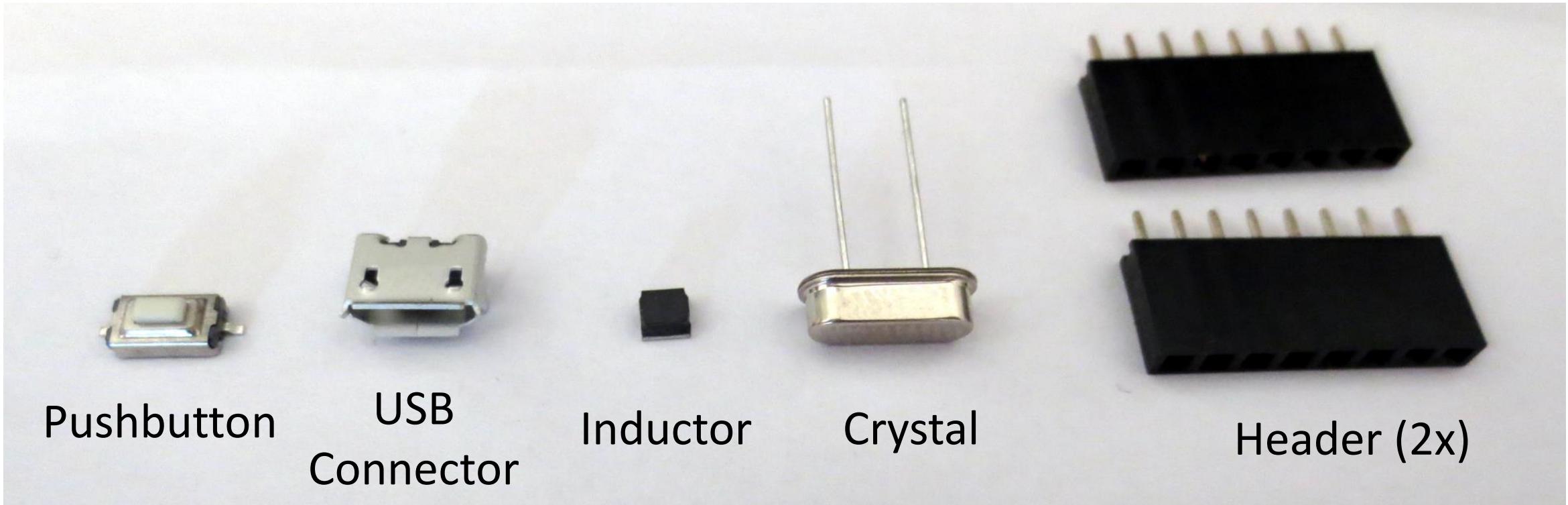
Total Price: \$37.87  
Weight: 54.41g

[SAVE TO CART](#)

# R0 Assembly

# Components that need to be manually assembled

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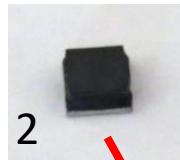
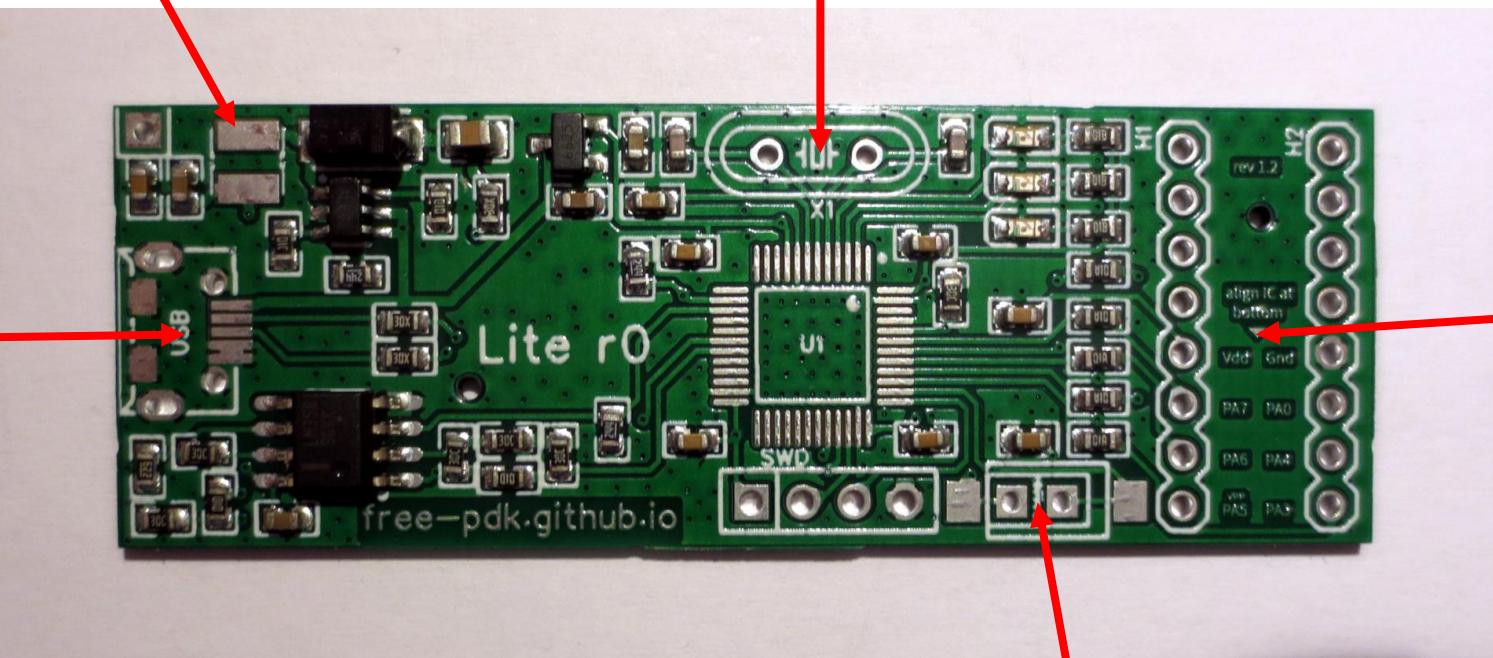


# Assembly locations

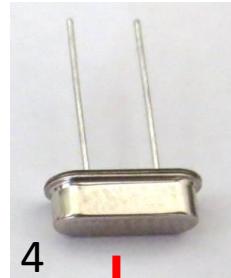
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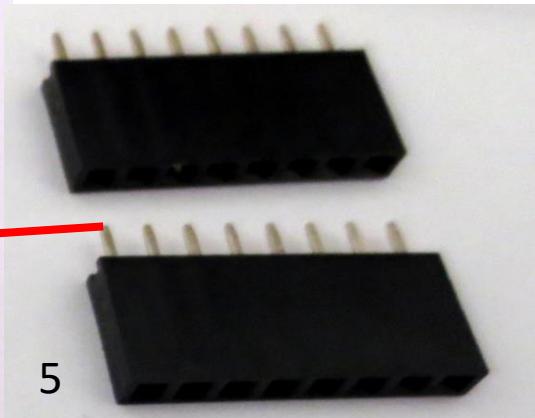
1



2



4



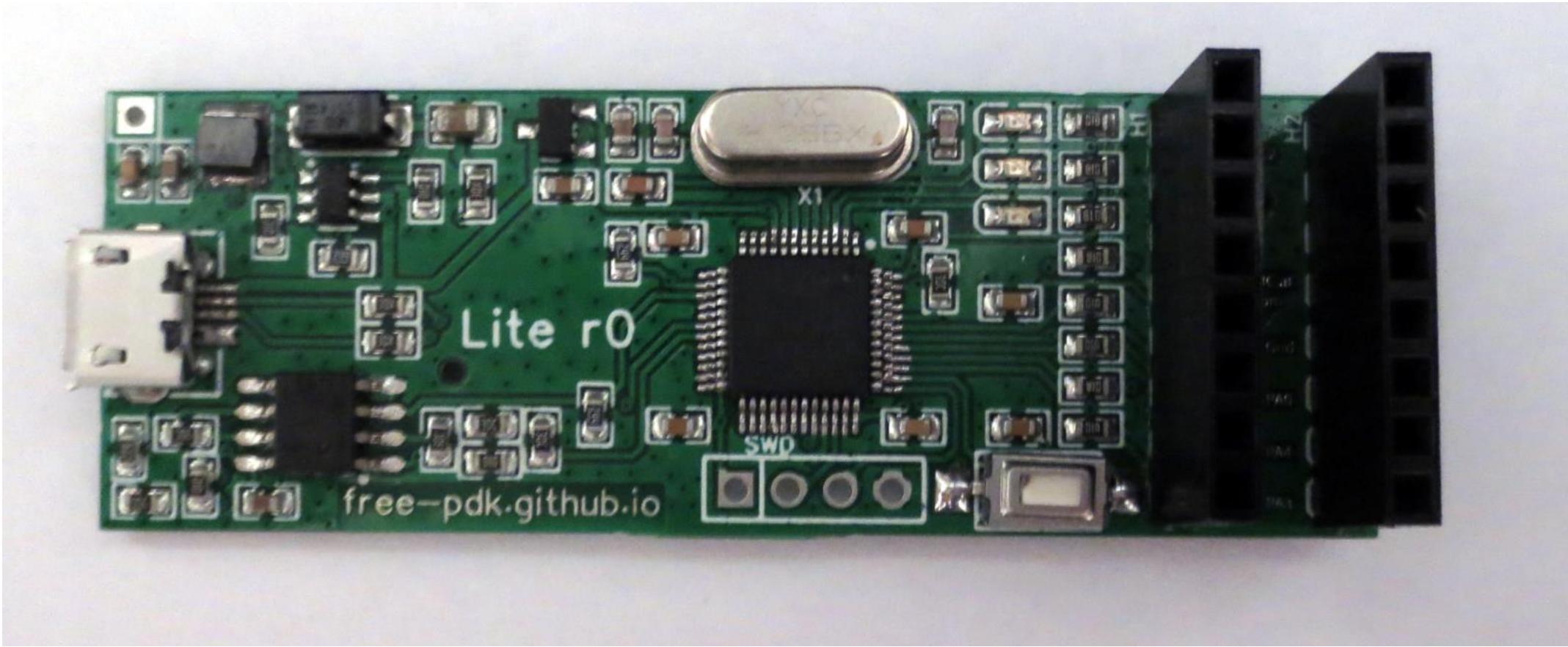
5



3

# Assembled programmer

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R1 Design

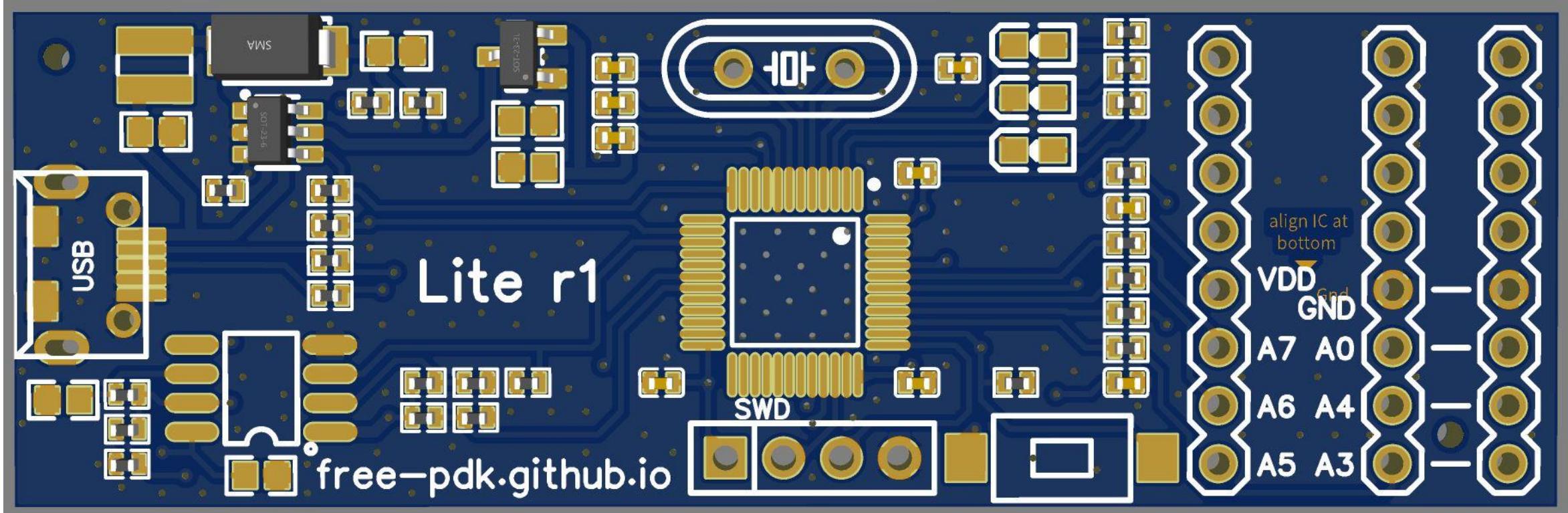
# Change log r0 -> r1

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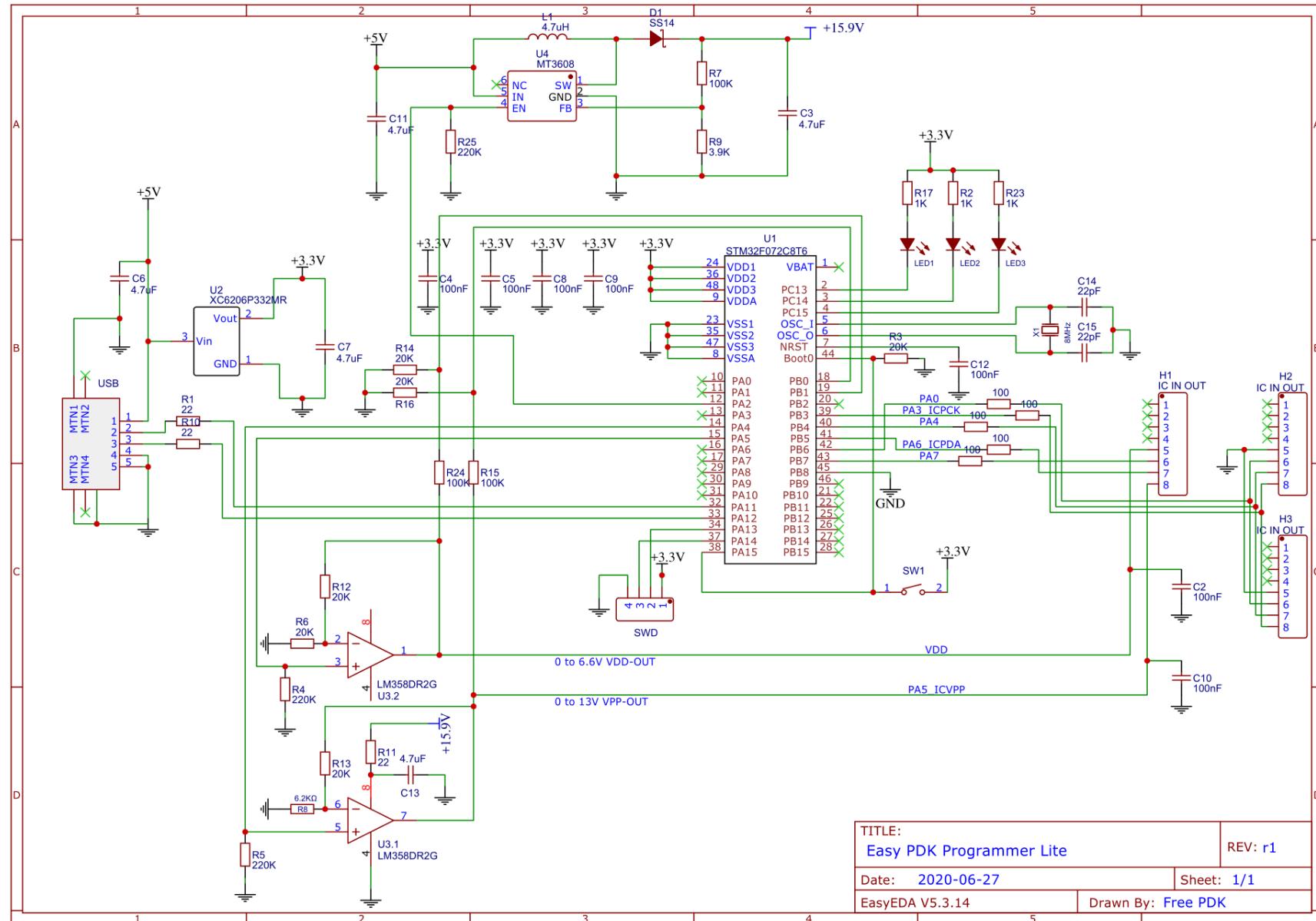
- Added keepout area to avoid direct connection between the two GND pins on the USB plug. This prevents formation of solder bridges during manual soldering.
- Removed „rev 1.2“ metallization mark to avoid confusion
- Corrected mistake: Change name of P2 in schematics to „Boot“ instead of GND.
- Create space for tooling holes during JLCPCB assembly:
  - Removed PINs to shortcut button -> Make button mandatory, allow space for mounting hole (It's a cheap part and more convenient to have when updating the firmware)
  - Remove GND pin header in top left corner to allow placement of mounting hole -> scope gnd can also be taken from SWD header or many other places.
- Converted „free-pdk.github.io“ inscription to silk screen for better visibility.
- Converted pin descriptions to silk screen for better visibility.
- Replaced almost all 0603 parts with 0402 parts to de-crowd layout and for some cost down.
- Went back to MT3608 boost converter, but with simplified filtering
- Connected enable pin of boost converter to MCU
- Rearranged current loop in boost converter to reference a single GND point.
- Added second row of headers to allow plugging in wide breakout boards
- Added fiducial holes for assembly

# R1 lite programmer, PCB

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# R1 lite programmer, schematics



# Requirements for boost converter



LM358-D.PDF

Limitation given by LM358 voltage buffer

- Max output current: 20 mA min, 40 mA typ.      -> Max booster current  $2 \times 40$  mA
- Out voltage high limit: 1.5 – 2 V below VCC      -> V<sub>PPmax</sub> is 10.5V, so V<sub>CCopamp</sub> ~13 V
- Ripple not so critical due to PSRR of LKM358. Lets assume <50mV V<sub>pp</sub>

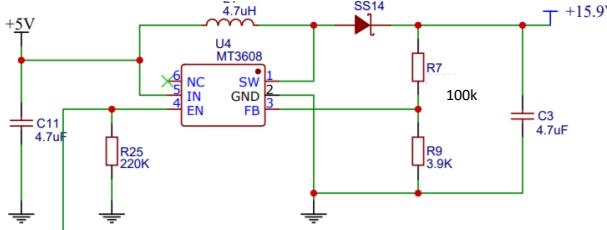
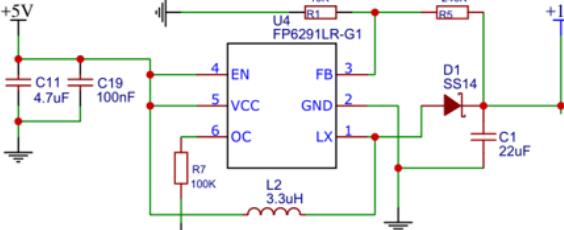
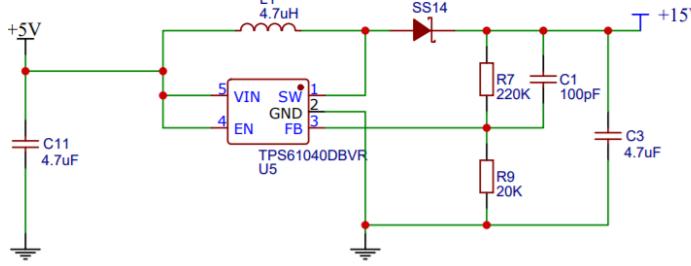
Limitation given by reference voltage divider (R8/R13 in original design)

- $3.3\text{ V} * (20\text{ kohm} + 6.2\text{ kohm}) / (6.2\text{ kohm}) = 13.9\text{ V}$  -> V<sub>CCopamp</sub> ~ 15 V

## Requirements for boost converter

- $V_{out} >= 15\text{ V}$ ,  $I_{max} \sim 2 \times 40\text{ mA}$ , <50 mV<sub>pp</sub> ripple

# Boost converter options

sdfsdf	Aerosemi MT3608	Feeling Tech FP6291	Texas Instruments TPS61040
Cost	\$0.098/pc + \$3.00 extended part fee per run	\$0.126 (basic part)	\$0.42 (basic part)
Circuit			
Notes	22 $\mu$ F output cap recommended -> replaced with 4.7 $\mu$ F + RC filter	22 $\mu$ F output cap recommended Addition current limiting resistor needed	Only requires small output capacitor Additional cap C1 needed
Design	<p>Vout = 15.9 V  <math>I_{max} = ???</math>  <math>D_{vout} &lt; 150 \text{ mV}</math> expected  <math>F_{max} \sim 1.2 \text{ MHz}</math>  MOSFET <math>R_{dson} 0.08 \text{ Ohm}</math></p> <p>Pulse frequency modulation feature should prevent ripple</p>	<p>Vout = 15 V (Max is 16V, nominal 12 V)  <math>I_{max} = ???</math>  <math>D_{vout} \sim 150 \text{ mV}</math> in current design  <math>F_{max} \sim 1 \text{ MHz}</math>  MOSFET <math>R_{dson} 0.2 \text{ Ohm}</math></p> <p>Audible inductor noise!</p>	<p>Vout = 14.8 V  <math>I_{max} = 50 \text{ mA}</math>  <math>D_{vout} &lt; 14.7 \text{ mV}</math>  <math>F_{max} \sim 1 \text{ MHz}</math>  MOSFET <math>R_{dson} 0.6 \text{ Ohm}</math></p>



MT3608.pdf



1812101116\_Feeling-Tech-FP6291LR-G1\_C18701.pdf



1809151118\_Texas-Instruments-TPS61040DBVR\_C7722.pdf

Pick this



# Boost converter design with TPS61040

- L=4.7  $\mu\text{H}$
- V<sub>d</sub> of SS14 schottky diode is  $\sim 0.3\text{V}$
- V<sub>out</sub>=14.8 V, R<sub>1</sub>= 220 kOhm, R<sub>2</sub>= 20 kOhm, C<sub>o</sub>=4.7  $\mu\text{F}$
- I<sub>peak</sub>= 400 mA + 5 V/4.7  $\mu\text{H}$ \*100 nS = 400 mA + 152 mA = 506 mA
- F<sub>smax</sub>= 1.4 MHz (1 MHz is allowed f<sub>smax</sub>, booster should not be loaded above 50 mA)
- F<sub>sload</sub>(20 mA)= 0.297 MHz
- F<sub>sload</sub>(0.5 mA)=7.43 kHz (this is the quiescent current of the LM358)
- I<sub>loadmax</sub>= 68 mA
- CFF  $\sim$  86 pF  $\rightarrow$  82 pF (Assuming 10 m
- dV<sub>OUT</sub>=14.7mV

The output voltage is calculated as:

$$V_{\text{OUT}} = 1.233 \text{ V} \times \left(1 + \frac{R_1}{R_2}\right)$$

The lower the switching frequency of the converter, the larger the feedforward capacitor value required. A good starting point is to use a 10-pF feedforward capacitor. As a first estimation, the required value for the feedforward capacitor at the operation point can also be calculated using the following formula:

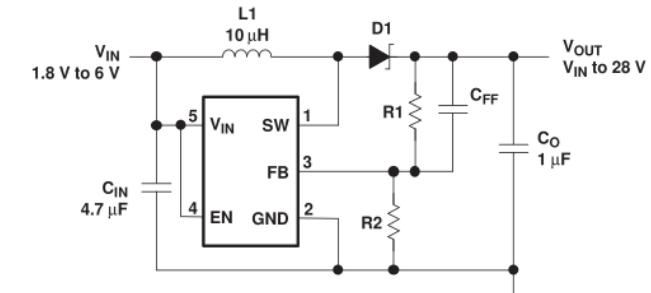
$$C_{\text{FF}} = \frac{1}{2 \times \pi \times \frac{f_S}{20} \times R_1}$$

Where:

R<sub>1</sub> = Upper resistor of voltage divider

f<sub>S</sub> = Switching frequency of the converter at the nominal load current (See the [Inductor Selection, Maximum Load Current](#) section for calculating the switching frequency)

C<sub>FF</sub> = Choose a value that comes closest to the result of the calculation



$$I_{\text{peak}(\text{typ})} = 400 \text{ mA} + \frac{V_{\text{IN}}}{L} \times 100 \text{ ns} \text{ for the TPS61040}$$

By selecting the TPS61040 or TPS61041, it is possible to tailor the design to the specific application current limit requirements. A lower current limit supports applications requiring lower output power and allows the use of an inductor with a lower current rating and a smaller form factor. A lower current limit usually has a lower output voltage ripple as well.

Maximum switching frequency is calculated by the following formula:

$$f_{\text{Smax}} = \frac{V_{\text{IN}(\text{min})} \times (V_{\text{OUT}} - V_{\text{IN}})}{I_p \times L \times V_{\text{OUT}}}$$

Where:

I<sub>p</sub> = Peak current as described in the [Peak Current Control](#) section

L = Selected inductor value

V<sub>IN(min)</sub> = The highest switching frequency occurs at the minimum input voltage

$$f_S(I_{\text{load}}) = \frac{2 \times I_{\text{load}} \times (V_{\text{OUT}} - V_{\text{IN}} + V_d)}{I_p^2 \times L}$$

Where:

I<sub>p</sub> = Peak current as described in the [Peak Current Control](#) section

L = Selected inductor value

I<sub>load</sub> = Nominal load current

V<sub>d</sub> = Rectifier diode forward voltage (typically 0.3V)

$$I_{\text{load max}} = \eta \frac{I_p^2 \times L \times f_{\text{Smax}}}{2 \times (V_{\text{OUT}} - V_{\text{IN}})}$$

Where:

I<sub>p</sub> = Peak current as described in the [Peak Current Control](#) section

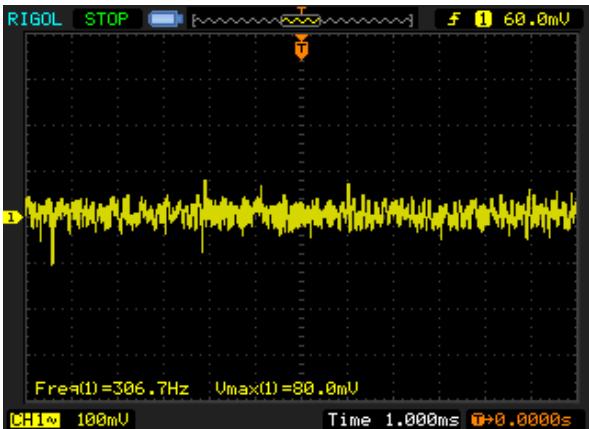
L = Selected inductor value

f<sub>Smax</sub> = Maximum switching frequency as calculated previously

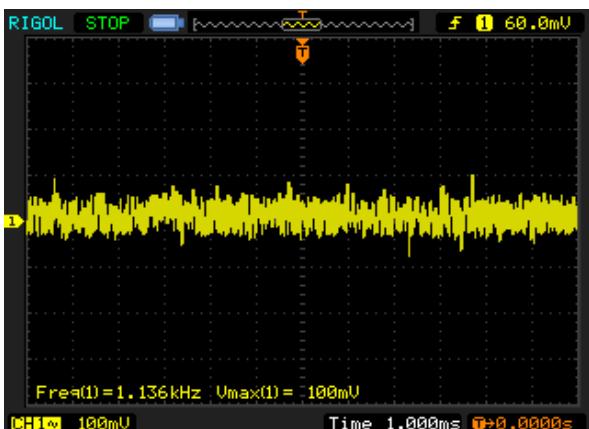
$\eta$  = Expected converter efficiency. Typically 70% to 85%

# Boost converter design with MT3608

- L=4.7  $\mu\text{H}$
- V<sub>d</sub> of SS14 schottky diode is  $\sim 0.3\text{V}$
- V<sub>out</sub>=15.9 V, R<sub>1</sub>= 100 kOhm, R<sub>2</sub>= 3.9 kOhm, C<sub>o</sub>=4.7  $\mu\text{F}$
- Output filtering
  - A 22  $\mu\text{F}$  cap is large and expensive, especially since not used elsewhere
  - Use 4.7  $\mu\text{F}$  instead in addition to existing RC filter, since PSRR of opamp will remove further noise:  $22 \text{ Ohm}/4.7\mu\text{F} \rightarrow f_c = 1.54 \text{ kHz}$



Original programmer with 47 $\mu$  cap supply at OPAMP after RC-Filter



Original programmer with removed cap supply at OPAMP after RC-Filter

## Cost of MLCC caps:

0603, 4.7  $\mu\text{F}$ , 16 V 0.0206 USD (same for 0805)  
0805, 10  $\mu\text{F}$ , 25 V 0.031 USD  
0805, 22  $\mu\text{F}$ , 25 V 0.068 USD  
1210, 47  $\mu\text{F}$ , 16 V 0.19 USD

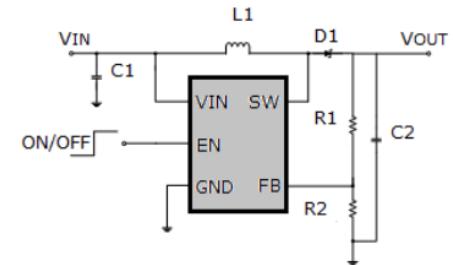


Figure 1. Basic Application Circuit

## Setting the Output Voltage

The internal reference V<sub>REF</sub> is 0.6V (Typical).The output voltage is divided by a resistor divider,R<sub>1</sub> and R<sub>2</sub> to the FB pin. The output voltage is given by

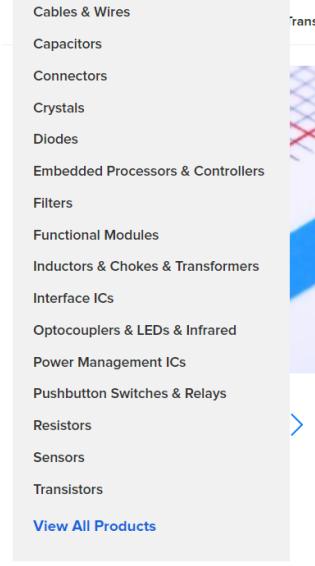
$$V_{OUT} = V_{REF} \times \left(1 + \frac{R_1}{R_2}\right)$$

## Inductor Selection

The recommended values of inductor are 4.7 to 22 $\mu\text{H}$ . Small size and better efficiency are the major concerns for portable device, such as MT3608 used for mobile phone. The inductor should have low core loss at 1.2MHz and low DCR for better efficiency. To avoid inductor saturation current rating should be considered.

## Capacitor Selection

Input and output ceramic capacitors of 22 $\mu\text{F}$  are recommended for MT3608 applications. For better voltage filtering, ceramic capacitors with low ESR are recommended. X5R and X7R types are suitable because of their wider voltage and temperature ranges.



See an Error?

## TAITEC HPC3015TF-4R7M

Manufacturer [TAITEC](#)

Mfr.Part # [HPC3015TF-4R7M](#)

LCSC Part # [C155140](#)

Package SMD,3x3x1.5mm

Customer #

[TAITEC HPC3015TF-4R7M](#)

EasyEDA Libraries [EasyEDA Model](#)

Description [4.7uH ±20% 1.2A 144mΩ SMD,3x3x1.5mm Power Inductors RoHS](#)

In stock: 5350

Ship Immediately

4100

Ship within 3 days

1250

+  
-

[Add to cart](#)

Minimum : 10 Multiples : 10

Packaging: Cut Tape

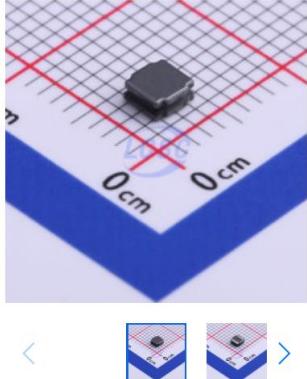
Unit Price US\$ 0.039254

Ext. Price US\$0.39

### Pricing(USD)

Sales Unit: Piece Full Reel: 2000

Qty.	Unit Price	Ext. Price
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## Ceaiya CR3015-6R8M

Manufacturer [Ceaiya](#)

Mfr.Part # [CR3015-6R8M](#)

LCSC Part # [C520295](#)

Package SMD,3.0x3.0x1.5mm

Customer #

[Ceaiya CR3015-6R8M](#)

Description [6.8uH ±20% 0.85A 200mΩ SMD,3.0x3.0x1.5mm Power Inductors RoHS](#)

In stock: 1910

+  
-

[Add to cart](#)

Minimum : 10 Multiples : 10

Packaging: Cut Tape

Unit Price US\$ 0.031865

Ext. Price US\$0.32

### Pricing(USD)

Sales Unit: Piece Full Reel: 2000

Qty.	Unit Price	Ext. Price
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**10+** US\$0.031865 US\$0.32

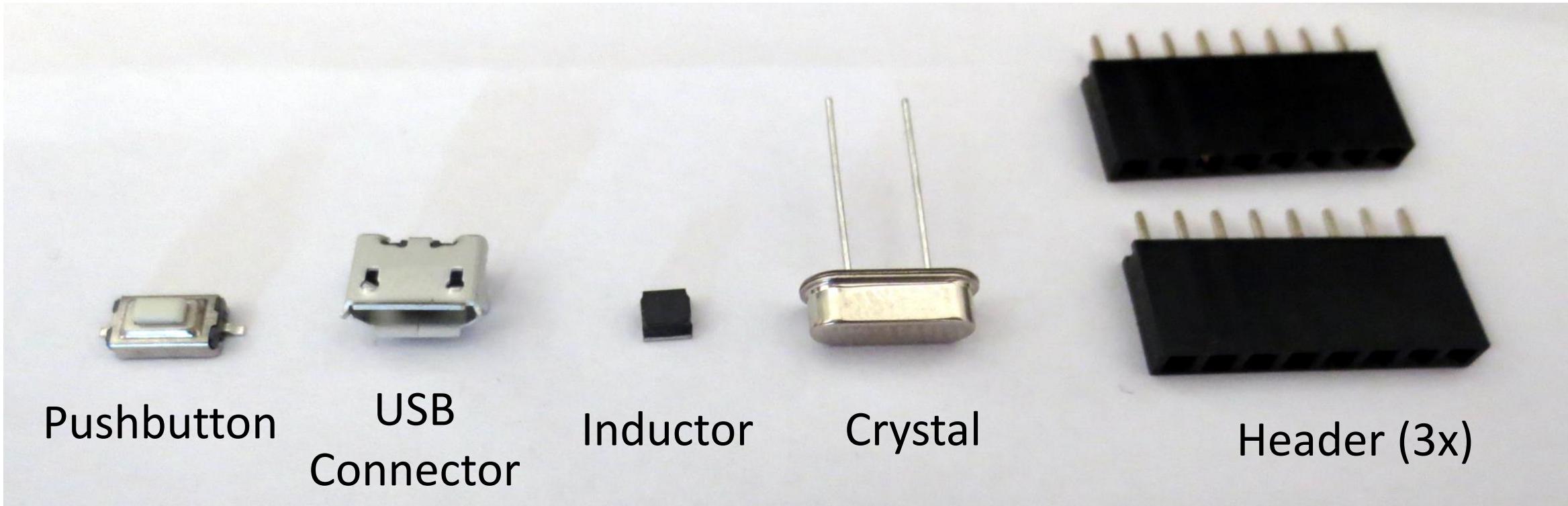
Images are for reference only.

[Add to Favourites](#)

# R1 Assembly

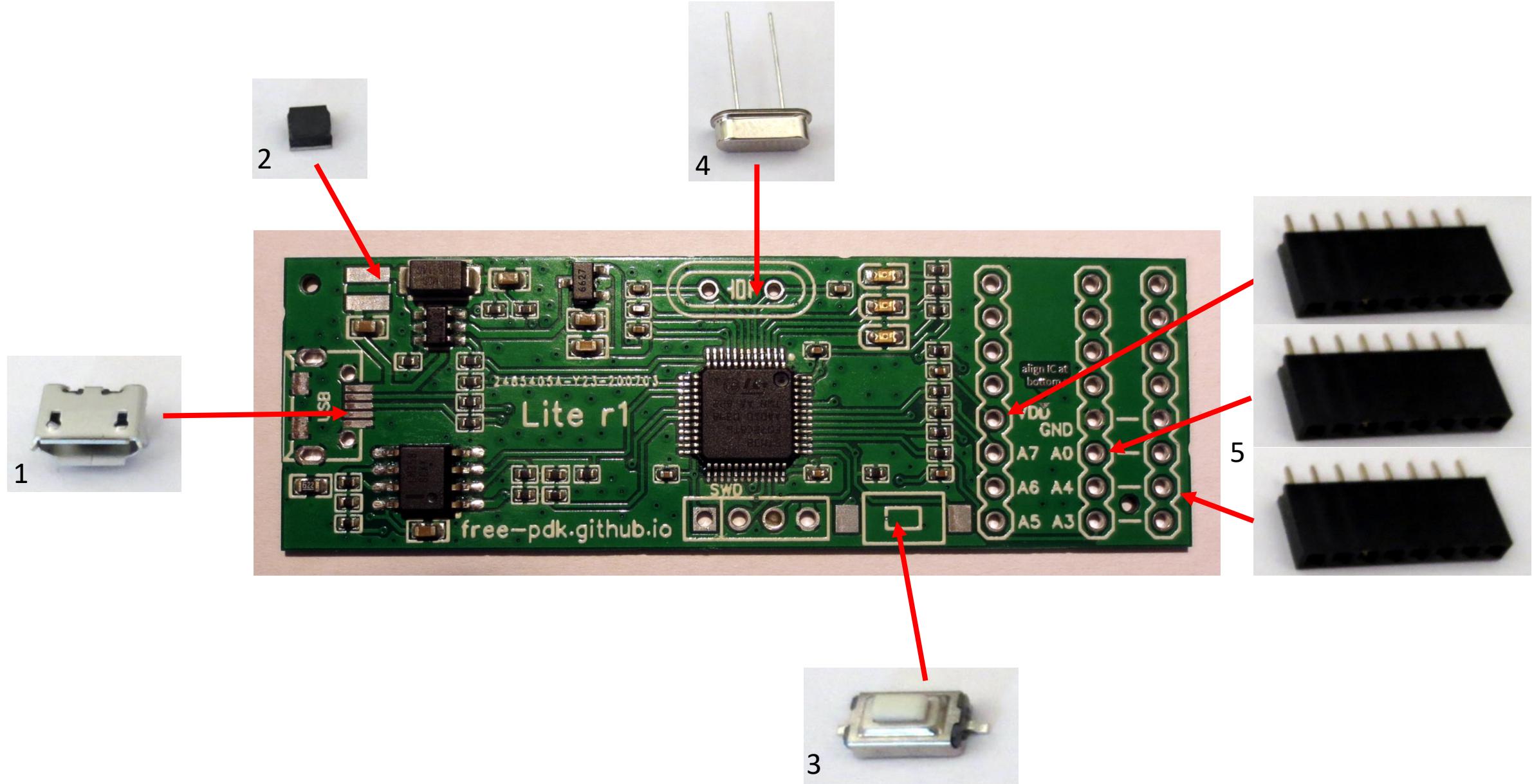
# Components that need to be manually assembled

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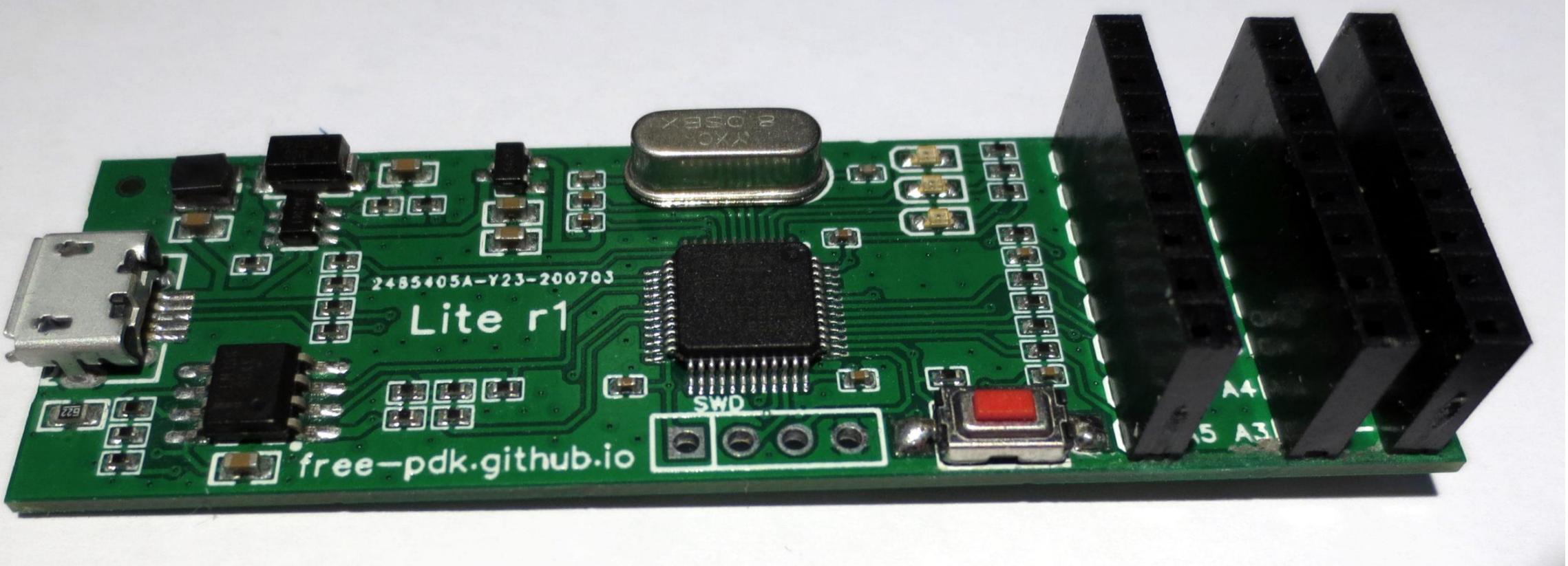
# Assembly locations

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# Assembled programmer

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# R1 Design Validation

# EasyPDKProg lite R1 – Design Validation

## Power supply

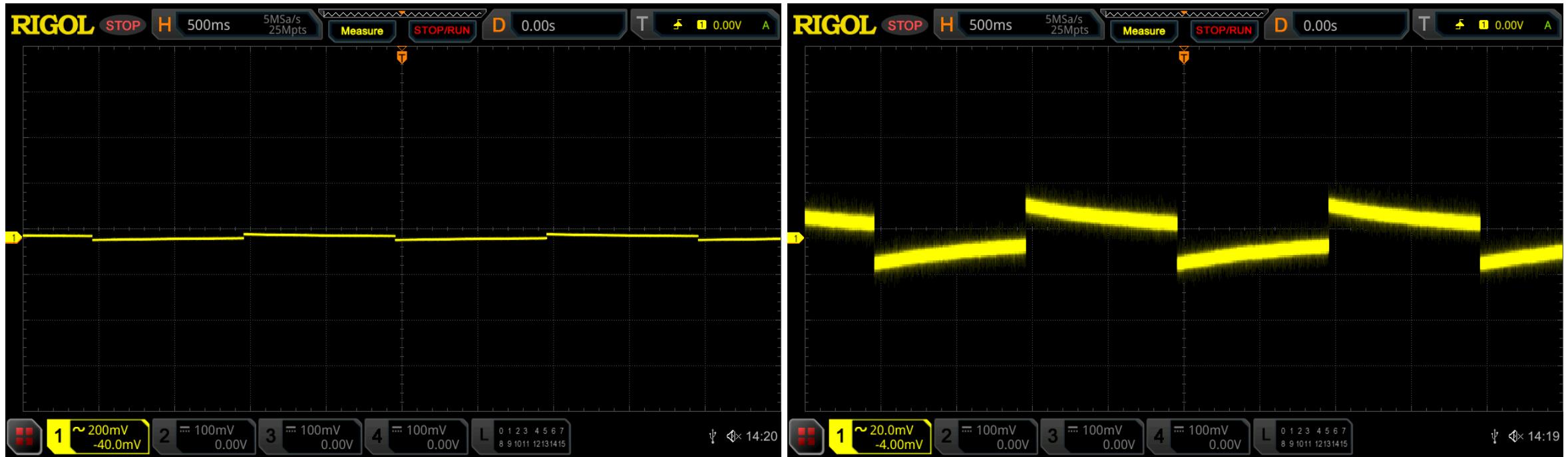
Test point	Measured	Expected	Result	Comment
5V Supply (@ USB port)	4.98 V	5.0 V	Pass	Ok, lower voltage since this is a different computer
15 V Boosted (@U3_18)	32.0 V	15.9 V	Fail	R7 was incorrectly set to 220k, switched to 100k
15 V Boosted (@U3_18)	15.8 V	15.9 V	Pass	With R7=100k
3.3 V LDO (@U2_2)	3.3 V	3.3 V	Pass	Ok
VDD idle (@ header)	5 mV	0 V	Pass	Offset voltage of Opamp due to non-negative supply. Still within acceptable limits.
VPP idle (@ header)	5 mV	0 V	Pass	Offset voltage of Opamp due to non-negative supply. Still within acceptable limits.
VDD test mode (@ header)	4.98 V	5.0 V	Pass	Using EASYPDKPROGTEST.EXE
VPP test mode (@ header)	4.97 V	5.0 V	Pass	Using EASYPDKPROGTEST.EXE

## Programming

Device	Test case (command)	Result	Comment
PFS173-S08	probe	Pass	
PFS173-S08	-n pfs173 erase	Pass	
PFS173-S08	-n pfs173 read out.txt	Pass	
PFS173-S08	-n pfs175 write main.ihx	Pass	uartsend – including IHRC calibration
PFS173-S08	-n pfs173 start	Pass	uartsend

# Boost converter loading

15 V power supply ripple (U3\_18)  
Loaded with blinky (lite r1 version)



- Very low visible ripple, even at 20 mV setting.
- => Boost converter filtering performs fine

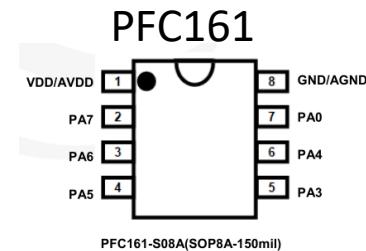
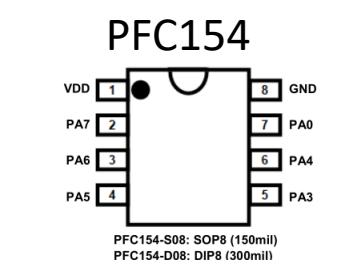
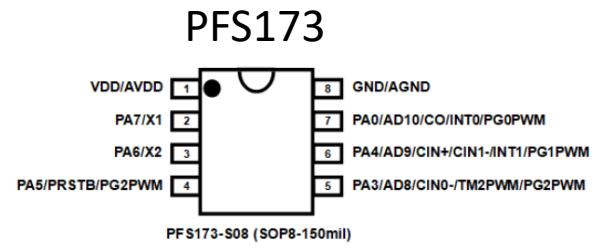
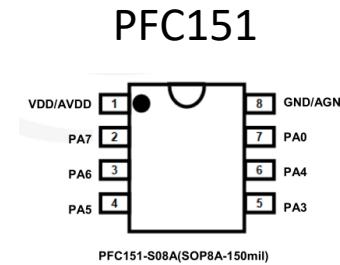
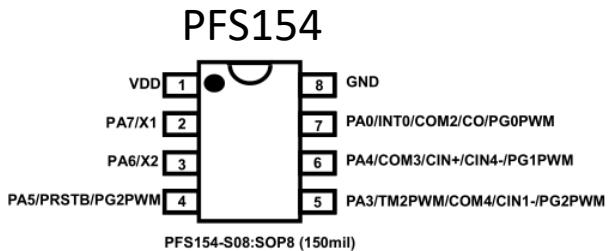
# Padauk Flash MCU Breakout Boards

CPLDCPU – June 27th, 2020

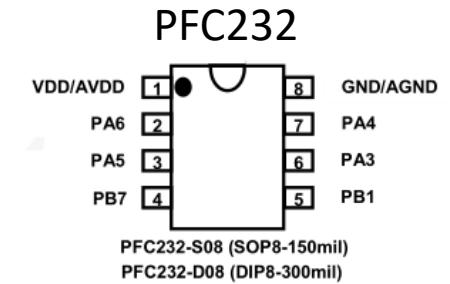
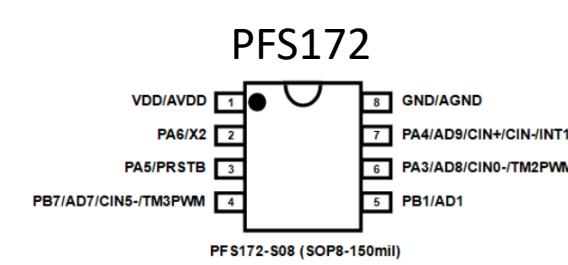


# Pinouts SO8 Flash variants

Type I



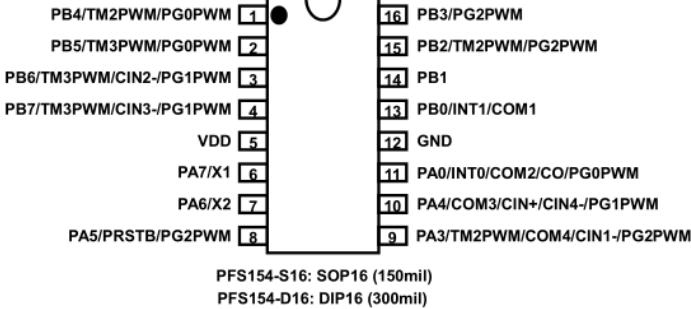
Type II



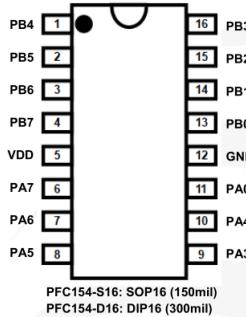
# Pinouts SO16 Flash variants

Type I

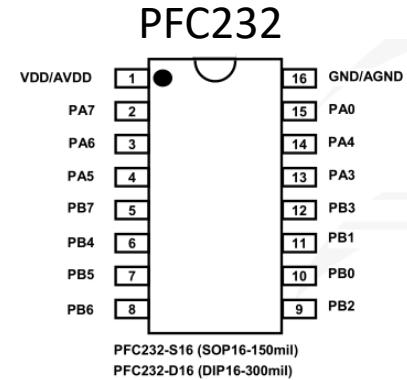
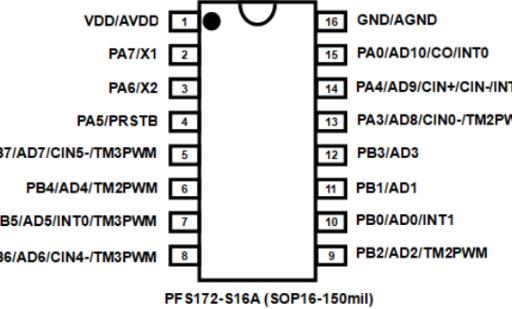
PFS154



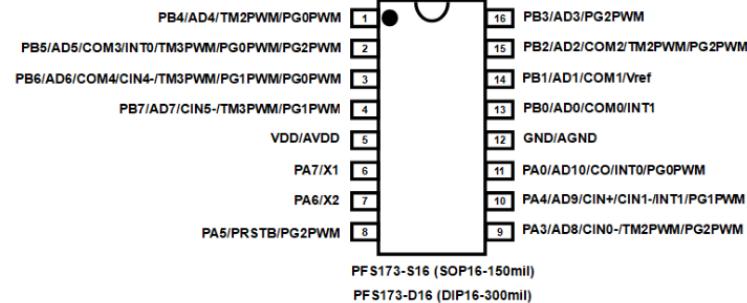
PFC154



PFS172



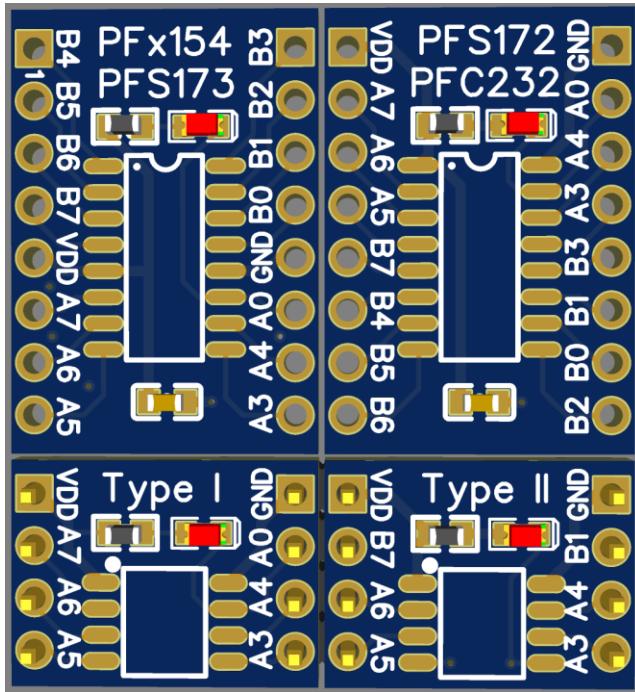
PFS173



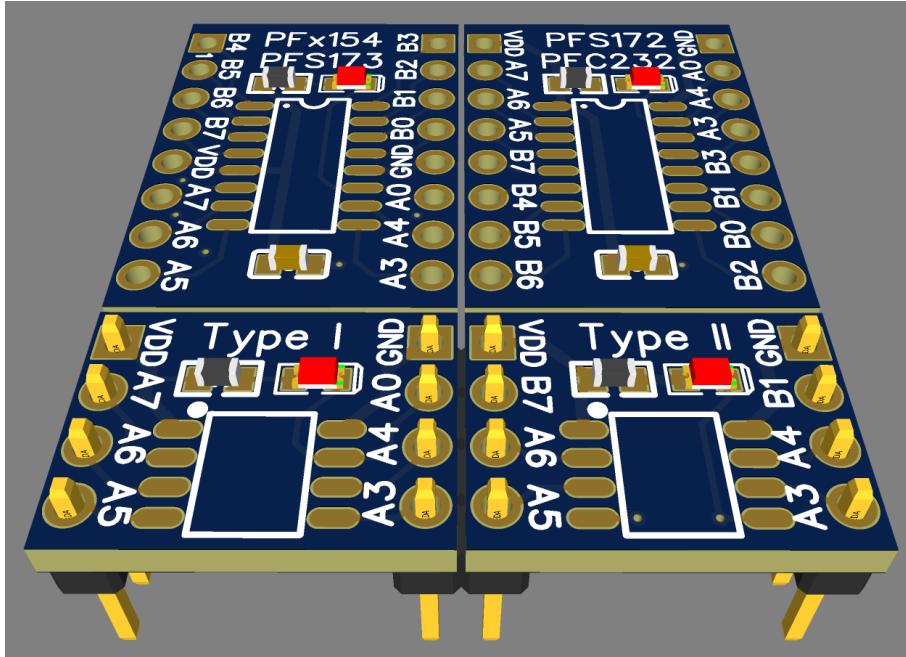
No SO16 package:  
PFC151    PFC161

# Plug-in Breakout boards

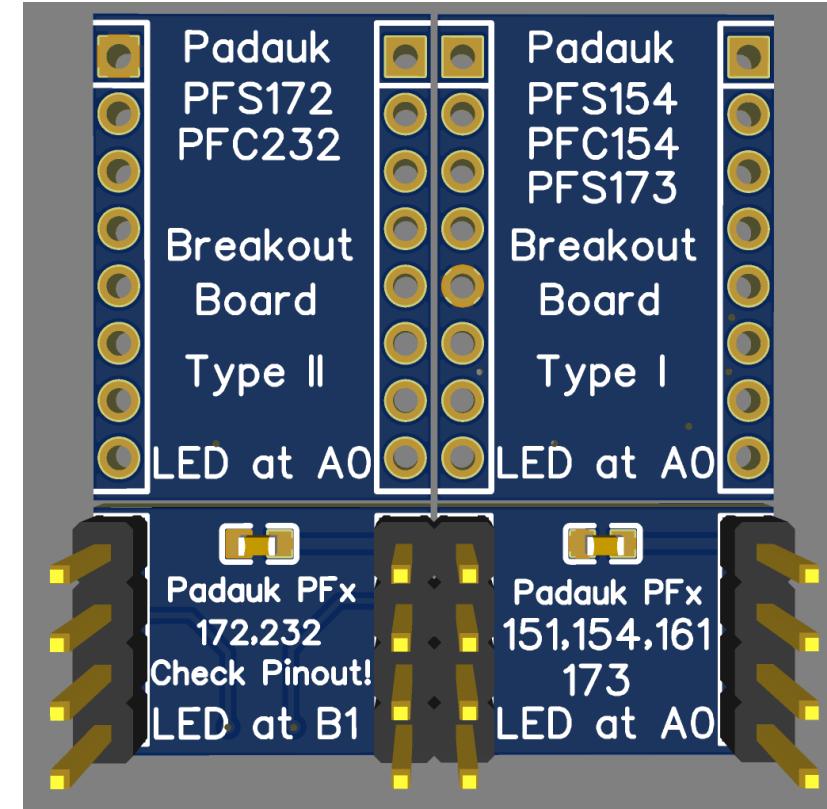
Top



Oblique



Bottom



# Photos of boards (Type I only)

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